

EVALUATION KIT
AVAILABLE

Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

MAX1438B

General Description

The MAX1438B octal, 12-bit analog-to-digital converter (ADC) features fully differential inputs, a pipelined architecture, and digital error correction incorporating a fully differential signal path. This ADC is optimized for low-power and high-dynamic performance in medical imaging instrumentation and digital communications applications. The MAX1438B operates from a 1.8V single supply and consumes only 913mW (114mW per channel) while delivering a 69.9dB (typ) signal-to-noise ratio (SNR) at a 5.3MHz input frequency. In addition to low operating power, the MAX1438B features a low-power standby mode for idle periods.

An internal 1.24V precision bandgap reference sets the full-scale range of the ADC. A flexible reference structure allows the use of an external reference for applications requiring increased accuracy or a different input voltage range. The reference architecture is optimized for low noise.

A single-ended clock controls the data-conversion process. An internal duty-cycle equalizer compensates for wide variations in clock duty cycle. An on-chip phase-locked loop (PLL) generates the high-speed serial low-voltage differential signal (LVDS) clock.

The MAX1438B has self-aligned serial LVDS outputs for data, clock, and frame-alignment signals. The output data is presented in two's-complement format.

The MAX1438B offers a maximum sample rate of 64Msps. This device is available in a small, 10mm x 10mm x 0.8mm, 68-pin thin QFN package with exposed pad and is specified for the extended industrial (-40°C to +85°C) temperature range.

Applications

Ultrasound and Medical Imaging
Instrumentation
Multichannel Communications

Features

- ◆ Excellent Dynamic Performance
 - 69.9dB SNR at 5.3MHz
 - 94dBc SFDR at 5.3MHz
- ◆ Ultra-Low Power
 - 114mW per Channel (Normal Operation)
- ◆ Serial LVDS Outputs
- ◆ Pin-Selectable LVDS/SLVS (Scalable Low-Voltage Signal) Mode
- ◆ LVDS Outputs Support Up to 30in FR4 Backplane Connections
- ◆ Test Mode for Digital Signal Integrity
- ◆ Fully Differential Analog Inputs
- ◆ Wide Differential Input Voltage Range (1.4V_{P-P})
- ◆ On-Chip 1.24V Precision Bandgap Reference
- ◆ Clock Duty-Cycle Equalizer
- ◆ Compact, 68-Pin Thin QFN Package with Exposed Pad
- ◆ Evaluation Kit Available (Order MAX1437BEVKIT)

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|--------------|----------------|-----------------|
| MAX1438BETK+ | -40°C to +85°C | 68 Thin QFN-EP* |

+ Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Pin Configuration appears at end of data sheet.



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ABSOLUTE MAXIMUM RATINGS

| | |
|--|-------------------------------------|
| AVDD to GND | -0.3V to +2.0V |
| CVDD to GND | -0.3V to +3.6V |
| OVDD to GND | -0.3V to +2.0V |
| IN_P, IN_N to GND | -0.3V to (V _{AVDD} + 0.3V) |
| CLK to GND | -0.3V to (V _{CVDD} + 0.3V) |
| OUT_P, OUT_N, FRAME_, CLKOUT_ to GND | -0.3V to (V _{OVDD} + 0.3V) |
| DT, SLVS/LVDS, LVDSTEST, PLL_, STBY REFIO, REFADJ, CMOUT to GND | -0.3V to (V _{AVDD} + 0.3V) |

| | |
|---|-----------------|
| Continuous Power Dissipation (T _A = +70°C) 68-Pin Thin QFN, 10mm x 10mm x 0.8mm (derate 70mW/°C above +70°C) | 4000mW |
| Operating Temperature Range | -40°C to +85°C |
| Maximum Junction Temperature | +150°C |
| Storage Temperature Range | -65°C to +150°C |
| Lead Temperature (soldering, 10s) | +300°C |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{AVDD} = 1.8V, V_{OVDD} = 1.8V, V_{CVDD} = 1.8V, V_{GND} = 0V, external V_{REFIO} = 1.24V, C_{REFIO} to GND = 0.1μF || 1.0μF, C_{REFP} to GND = 10μF, C_{REFN} to GND = 10μF, f_{CLK} = 64MHz (50% duty cycle), DT = 0, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|--------------------|--------------------------------------|------|-------|------|------------------|
| DC ACCURACY (Note 2) | | | | | | |
| Resolution | N | | 12 | | | Bits |
| Integral Nonlinearity | INL | | | ±0.4 | ±2.5 | LSB |
| Differential Nonlinearity | DNL | No missing codes over temperature | | ±0.25 | ±1 | LSB |
| Offset Error | | | | | ±0.5 | %FS |
| Gain Error | | | -3 | ±0.5 | +2 | %FS |
| ANALOG INPUTS (IN_P, IN_N) | | | | | | |
| Input Differential Range | V _{ID} | Differential input | | 1.4 | | V _{P-P} |
| Common-Mode Voltage Range | V _{CMO} | | | 0.76 | | V |
| Common-Mode Voltage Range Tolerance | | (Note 3) | | ±50 | | mV |
| Differential Input Impedance | R _{IN} | Switched capacitor load | | 2 | | kΩ |
| Differential Input Capacitance | C _{IN} | | | 12.5 | | pF |
| CONVERSION RATE | | | | | | |
| Maximum Conversion Rate | f _S MAX | | 64 | | | MHz |
| Minimum Conversion Rate | f _S MIN | | | 4.0 | | MHz |
| Data Latency | | | | 6.5 | | Cycles |
| DYNAMIC CHARACTERISTICS (Differential Inputs, 4096-Point FFT) (Note 2) | | | | | | |
| Signal-to-Noise Ratio | SNR | f _{IN} = 5.3MHz at -0.5dBFS | | 69.9 | | dB |
| | | f _{IN} = 20MHz at -0.5dBFS | 67 | 69.6 | | |
| Signal-to-Noise and Distortion | SINAD | f _{IN} = 5.3MHz at -0.5dBFS | | 69.8 | | dB |
| | | f _{IN} = 20MHz at -0.5dBFS | 67 | 69.6 | | |
| Effective Number of Bits | ENOB | f _{IN} = 5.3MHz at -0.5dBFS | | 11.4 | | Bits |
| | | f _{IN} = 20MHz at -0.5dBFS | 10.8 | 11.4 | | |
| Spurious-Free Dynamic Range | SFDR | f _{IN} = 5.3MHz at -0.5dBFS | | 94 | | dBc |
| | | f _{IN} = 20MHz at -0.5dBFS | 79 | 93 | | |

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MAX1438B

ELECTRICAL CHARACTERISTICS (continued)

(V_{AVDD} = 1.8V, V_{OVDD} = 1.8V, V_{CVDD} = 1.8V, V_{GND} = 0V, external V_{REFIO} = 1.24V, C_{REFIO} to GND = 0.1μF || 1.0μF, C_{REFP} to GND = 10μF, C_{REFN} to GND = 10μF, f_{CLK} = 64MHz (50% duty cycle), DT = 0, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|---|---------------------|--|------|--------------------------|------|--------------------|
| Total Harmonic Distortion | THD | f _{IN} = 5.3MHz at -0.5dBFS | | -95 | | dBc |
| | | f _{IN} = 20MHz at -0.5dBFS | | -92 | -79 | |
| Intermodulation Distortion | IMD | f ₁ = 5.3MHz at -6.5dBFS f ₂ = 6.3MHz at -6.5dBFS | | 89.3 | | dBc |
| Third-Order Intermodulation | IM3 | f ₁ = 5.3MHz at -6.5dBFS f ₂ = 6.3MHz at -6.5dBFS | | 97.5 | | dBc |
| Aperture Jitter | t _{AJ} | Figure 10 | | < 0.4 | | ps _{RMS} |
| Aperture Delay | t _{AD} | Figure 10 | | 1 | | ns |
| Small-Signal Bandwidth | SSBW | Input at -20dBFS | | 100 | | MHz |
| Full-Power Bandwidth | LSBW | Input at -0.5dBFS | | 100 | | MHz |
| Output Noise | | IN_P = IN_N | | 0.44 | | LSB _{RMS} |
| Overrange Recovery Time | t _{OR} | R _S = 25Ω, C _S = 50pF | | 1 | | Clock cycle |
| INTERNAL REFERENCE | | | | | | |
| REFADJ Internal Reference-Mode Enable Voltage | | (Note 4) | | | 0.1 | V |
| REFADJ Low-Leakage Current | | | | 1.5 | | mA |
| REFIO Output Voltage | V _{REFIO} | | 1.18 | 1.24 | 1.30 | V |
| Reference Temperature Coefficient | T _{CREFIO} | | | 120 | | ppm/°C |
| EXTERNAL REFERENCE | | | | | | |
| REFADJ External Reference-Mode Enable Voltage | | (Note 4) | | V _{AVDD} - 0.1V | | V |
| REFADJ High-Leakage Current | | | | 200 | | μA |
| REFIO Input Voltage | | | | 1.24 | | V |
| REFIO Input Voltage Tolerance | | | | ±5 | | % |
| REFIO Input Current | I _{REFIO} | | | < 1 | | μA |
| COMMON-MODE OUTPUT (CMOUT) | | | | | | |
| CMOUT Output Voltage | V _{CMOUT} | | | 0.76 | | V |
| CLOCK INPUT (CLK) | | | | | | |
| Input High Voltage | V _{CLKH} | | | 0.8 x V _{AVDD} | | V |
| Input Low Voltage | V _{CLKL} | | | 0.2 x V _{AVDD} | | V |
| Clock Duty Cycle | | | | 50 | | % |
| Clock Duty-Cycle Tolerance | | | | ±30 | | % |
| Input Leakage | D _{IIN} | Input at GND | | 5 | | μA |
| | | Input at V _{AVDD} | | 80 | | |
| Input Capacitance | D _{CIN} | | | 5 | | pF |

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ELECTRICAL CHARACTERISTICS (continued)

($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, external $V_{REFIO} = 1.24V$, C_{REFIO} to GND = $0.1\mu F$ || $1.0\mu F$, C_{REFP} to GND = $10\mu F$, C_{REFN} to GND = $10\mu F$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS |
|--|----------------------|--|--------------------------|-------------------------|-------|------|-------|
| DIGITAL INPUTS (PLL_, LVDSTEST, DT, SLVS, STBY) | | | | | | | |
| Input High Threshold | V _{IH} | | | 0.8 x V _{AVDD} | | V | |
| Input Low Threshold | V _{IL} | | | 0.2 x V _{AVDD} | | V | |
| Input Leakage | D _{IIN} | Input at GND | | 5 | | μA | |
| | | Input at V _{AVDD} | | 80 | | | |
| Input Capacitance | DC _{IN} | | | 5 | | pF | |
| LVDS OUTPUTS (OUT_P, OUT_N), SLVS/LVDS = 0 | | | | | | | |
| Differential Output Voltage | VO _{HDIFF} | R _{TERM} = 100Ω | | 250 | 450 | mV | |
| Output Common-Mode Voltage | VO _{CM} | R _{TERM} = 100Ω | | 1.125 | 1.375 | V | |
| Rise Time (20% to 80%) | t _{RL} | R _{TERM} = 100Ω, C _{LOAD} = 5pF | | 350 | | ps | |
| Fall Time (80% to 20%) | t _{FL} | R _{TERM} = 100Ω, C _{LOAD} = 5pF | | 350 | | ps | |
| SLVS OUTPUTS (OUT_P, OUT_N, CLKOUTP, CLKOUTN, FRAMEP, FRAMEN), SLVS/LVDS = 1, DT = 1 | | | | | | | |
| Differential Output Voltage | VO _{HDIFF} | R _{TERM} = 100Ω | | 205 | | mV | |
| Output Common-Mode Voltage | VO _{CM} | R _{TERM} = 100Ω | | 220 | | mV | |
| Rise Time (20% to 80%) | t _{RS} | R _{TERM} = 100Ω, C _{LOAD} = 5pF | | 320 | | ps | |
| Fall Time (80% to 20%) | t _{FS} | R _{TERM} = 100Ω, C _{LOAD} = 5pF | | 320 | | ps | |
| STANDBY MODE (STBY) | | | | | | | |
| STBY Fall to Output Enable | t _{ENABLE} | | | 200 | | μs | |
| STBY Rise to Output Disable | t _{DISABLE} | | | 60 | | ns | |
| POWER REQUIREMENTS | | | | | | | |
| AVDD Supply Voltage Range | V _{AVDD} | | | 1.7 | 1.8 | 1.9 | V |
| OVDD Supply Voltage Range | V _{OVDD} | | | 1.7 | 1.8 | 1.9 | V |
| CVDD Supply Voltage Range | V _{CVDD} | | | 1.7 | 1.8 | 3.5 | V |
| AVDD Supply Current | I _{AVDD} | f _{IN} = 20MHz at -0.5dBFS | STBY = 0, DT = 0 | 422 | | 465 | mA |
| | | | STBY = 0, DT = 1 | 422 | | | |
| | | | STBY = 1, no clock input | 37 | | | |
| OVDD Supply Current | I _{OVDD} | f _{IN} = 20MHz at -0.5dBFS | STBY = 0 | 85 | | 110 | mA |
| | | | STBY = 0, DT = 1 | 85 | | | |
| | | | STBY = 1, no clock input | 16 | | μA | |
| CVDD Supply Current | I _{CVDD} | CVDD is used only to bias ESD-protection diodes on CLK input, Figure 2 | | 0 | | mA | |
| Power Dissipation | P _{DISS} | f _{IN} = 20MHz at -0.5dBFS | | 913 | | 1035 | mW |

Octal, 12-Bit, 64MSPS, 1.8V ADC with Serial LVDS Outputs

ELECTRICAL CHARACTERISTICS (continued)

($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, external $V_{REFIO} = 1.24V$, C_{REFIO} to GND = $0.1\mu F$ || $1.0\mu F$, C_{REFP} to GND = $10\mu F$, C_{REFN} to GND = $10\mu F$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
|--|----------|----------------------------|--------------------------|--------------------------|-----|---------|
| TIMING CHARACTERISTICS (Note 5) | | | | | | |
| Data Valid to CLKOUT Rise/Fall | t_{OD} | Figure 5 (Note 6) | $(t_{SAMPLE}/24) - 0.15$ | $(t_{SAMPLE}/24) + 0.15$ | | ns |
| CLKOUT Output-Width High | t_{CH} | Figure 5 | $t_{SAMPLE}/12$ | | | ns |
| CLKOUT Output-Width Low | t_{CL} | Figure 5 | $t_{SAMPLE}/12$ | | | ns |
| FRAME Rise to CLKOUT Rise | t_{CF} | Figure 4 (Note 6) | $(t_{SAMPLE}/24) - 0.15$ | $(t_{SAMPLE}/24) + 0.15$ | | ns |
| Sample CLK Rise to FRAME Rise | t_{SF} | Figure 4 (Note 6) | $(t_{SAMPLE}/2) + 1.1$ | $(t_{SAMPLE}/2) + 2.6$ | | ns |
| Crosstalk | | (Note 2) | -73 | | | dB |
| Gain Matching | CGM | $f_{IN} = 5.3MHz$ (Note 2) | ± 0.1 | | | dB |
| Phase Matching | CPM | $f_{IN} = 5.3MHz$ (Note 2) | ± 0.25 | | | Degrees |

Note 1: Specifications at $T_A \geq +25^\circ C$ are guaranteed by production testing. Specifications at $T_A < +25^\circ C$ are guaranteed by design and characterization and not subject to production testing.

Note 2: See definition in the *Parameter Definitions* section at the end of this data sheet.

Note 3: See the *Common-Mode Output (CMOUT)* section.

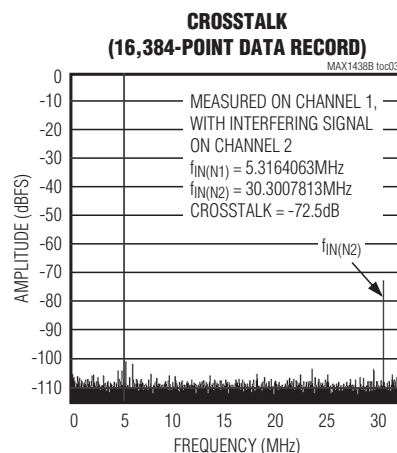
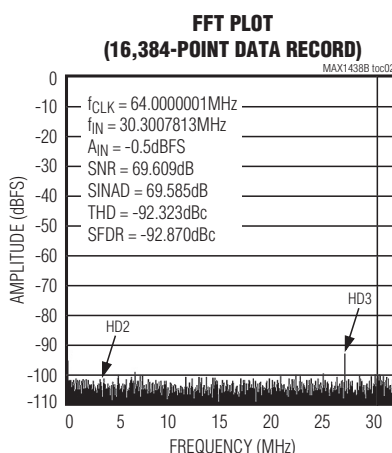
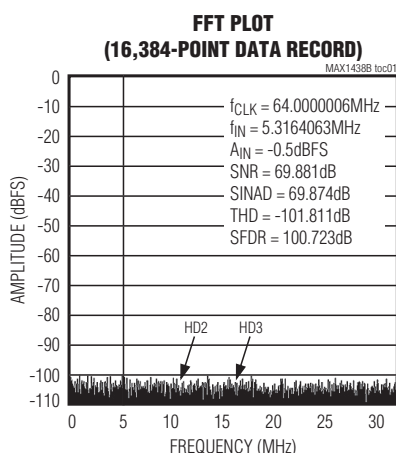
Note 4: Connect REFADJ to GND directly to enable internal reference mode. Connect REFADJ to AVDD directly to disable the internal bandgap reference and enable external reference mode.

Note 5: Data valid to CLKOUT rise/fall timing is measured from 50% of data output level to 50% of clock output level.

Note 6: Guaranteed by design and characterization. Not subject to production testing.

Typical Operating Characteristics

($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, internal reference, differential input at -0.5dBFS, $f_{IN} = 5.3MHz$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $C_{LOAD} = 10pF$, $T_A = +25^\circ C$, unless otherwise noted.)

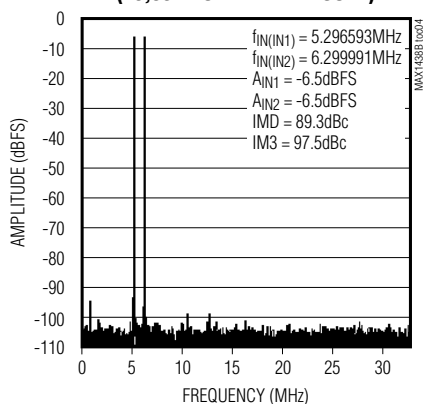


Octal, 12-Bit, 64Mps, 1.8V ADC with Serial LVDS Outputs

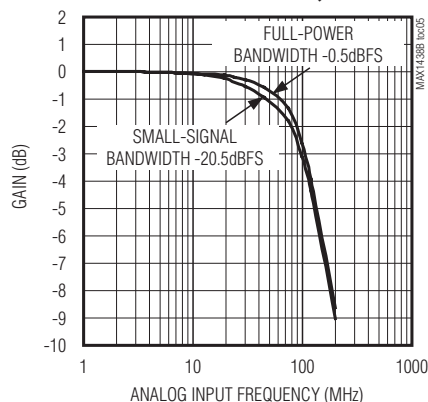
Typical Operating Characteristics (continued)

($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, internal reference, differential input at $-0.5dBFS$, $f_{IN} = 5.3MHz$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $C_{LOAD} = 10pF$, $T_A = +25^\circ C$, unless otherwise noted.)

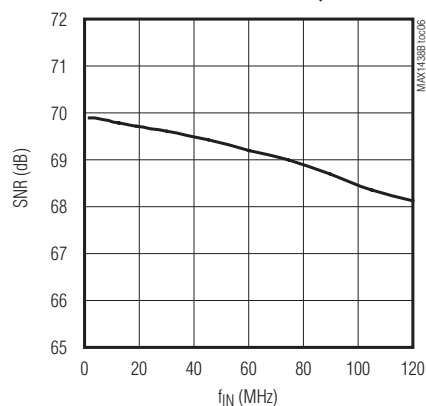
**TWO-TONE INTERMODULATION DISTORTION
(16,384-POINT DATA RECORD)**



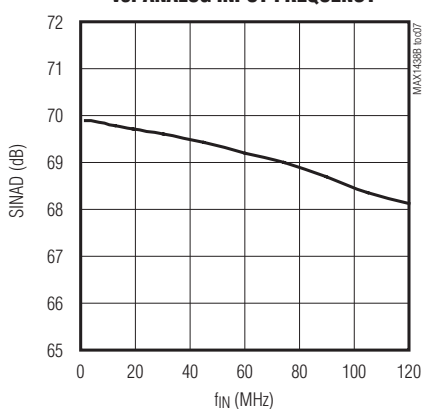
**BANDWIDTH
vs. ANALOG INPUT FREQUENCY**



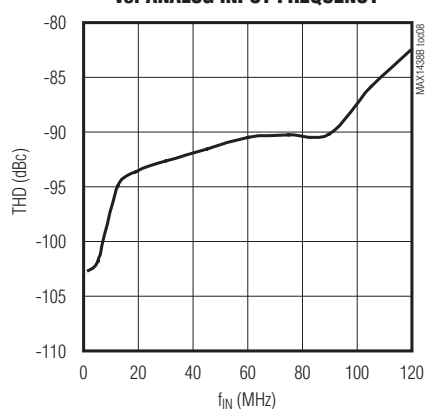
**SIGNAL-TO-NOISE RATIO
vs. ANALOG INPUT FREQUENCY**



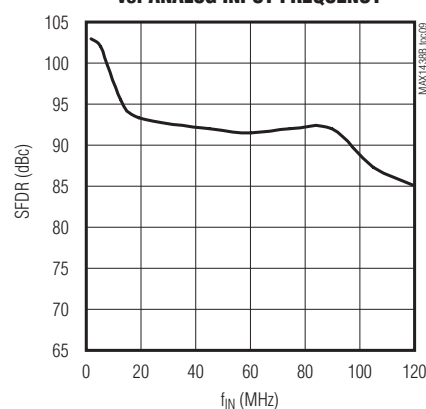
**SIGNAL-TO-NOISE PLUS DISTORTION
vs. ANALOG INPUT FREQUENCY**



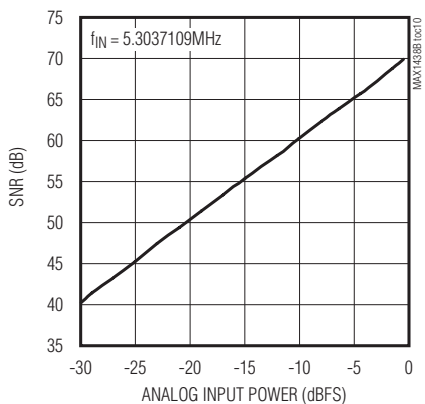
**TOTAL HARMONIC DISTORTION
vs. ANALOG INPUT FREQUENCY**



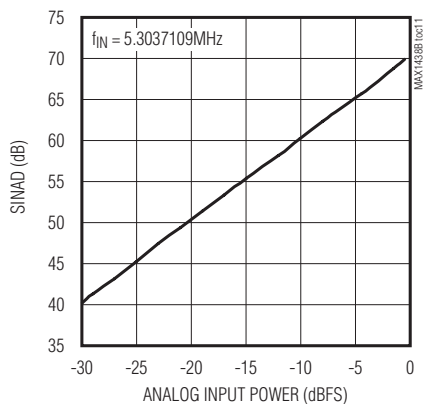
**SPURIOUS-FREE DYNAMIC RANGE
vs. ANALOG INPUT FREQUENCY**



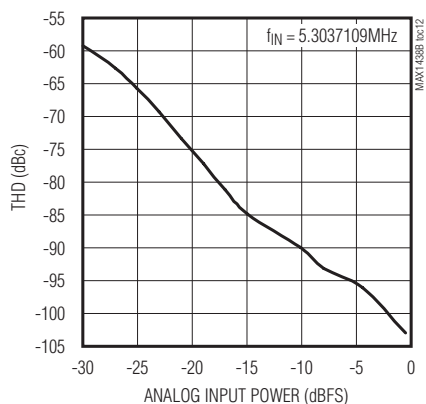
**SIGNAL-TO-NOISE RATIO
vs. ANALOG INPUT POWER**



**SIGNAL-TO-NOISE PLUS DISTORTION
vs. ANALOG INPUT POWER**



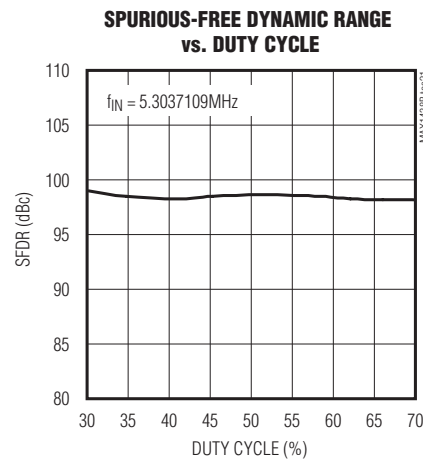
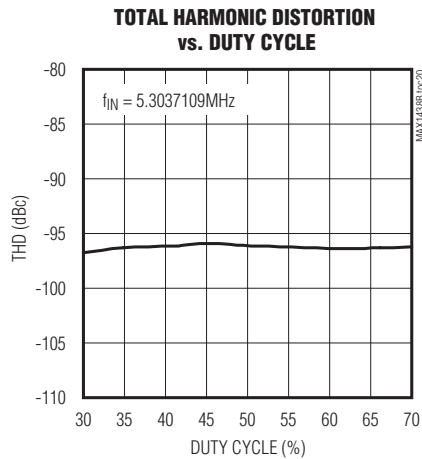
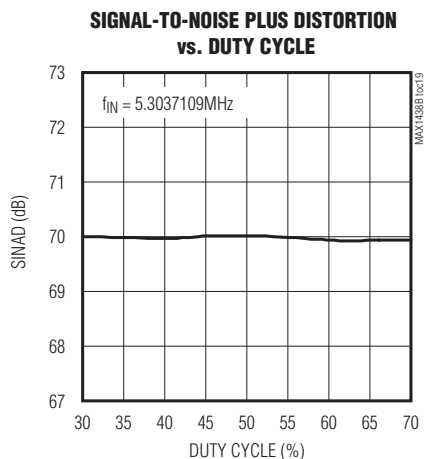
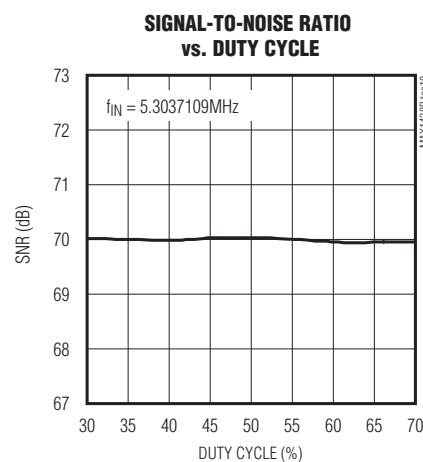
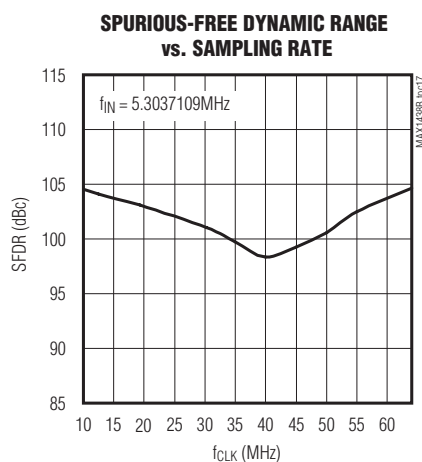
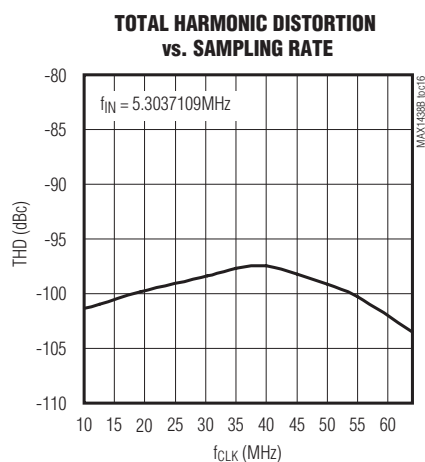
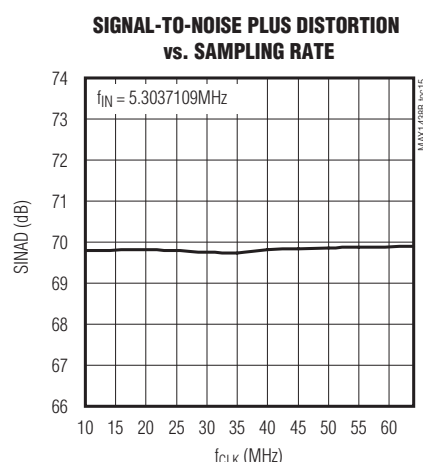
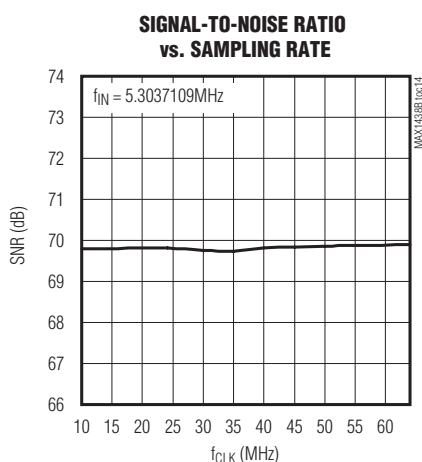
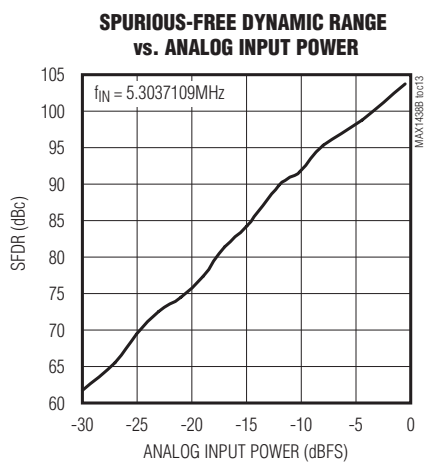
**TOTAL HARMONIC DISTORTION
vs. ANALOG INPUT POWER**



Octal, 12-Bit, 64Mps, 1.8V ADC with Serial LVDS Outputs

Typical Operating Characteristics (continued)

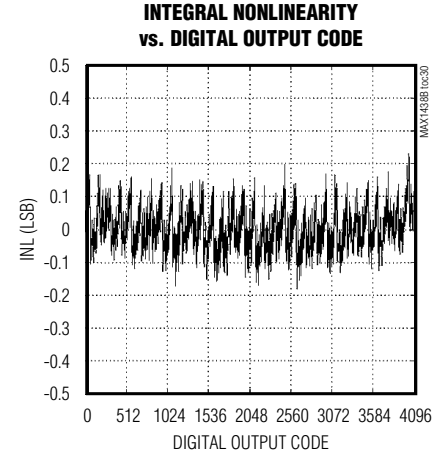
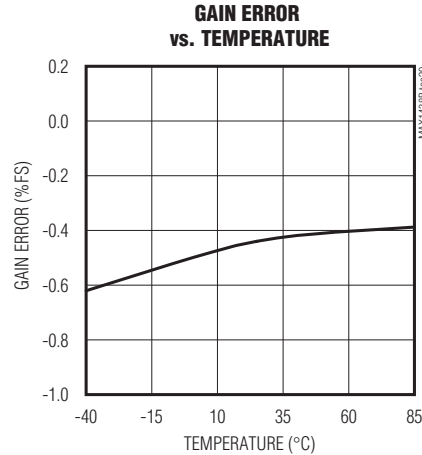
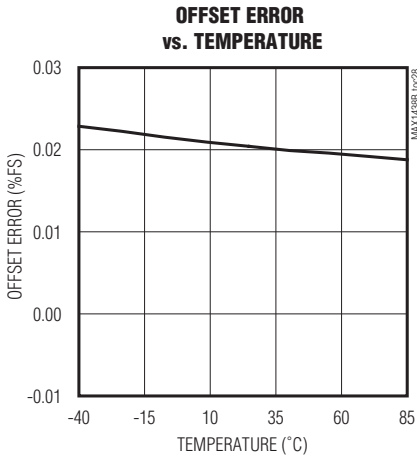
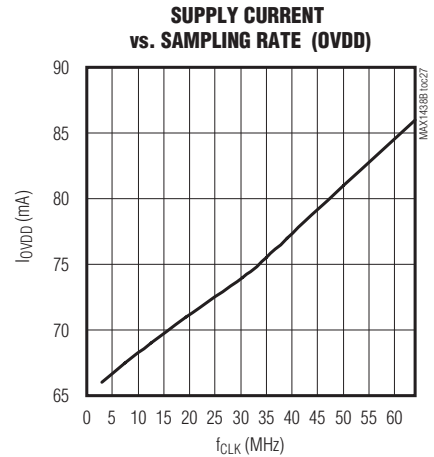
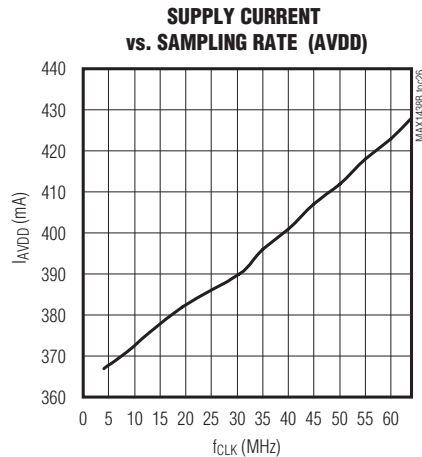
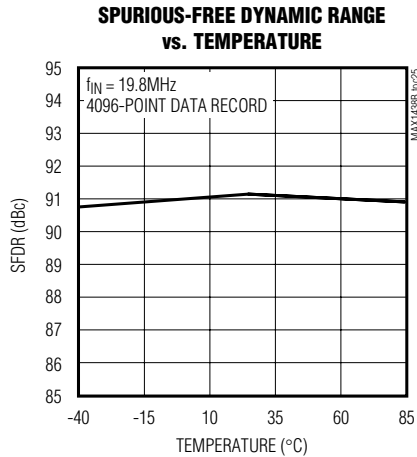
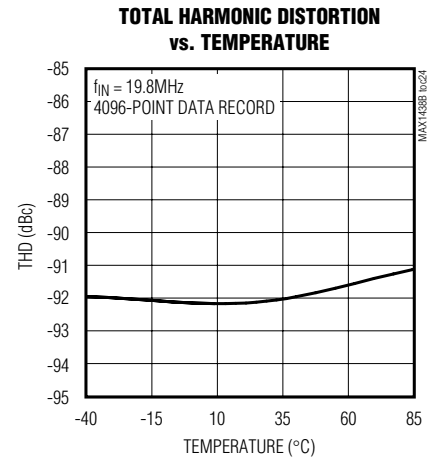
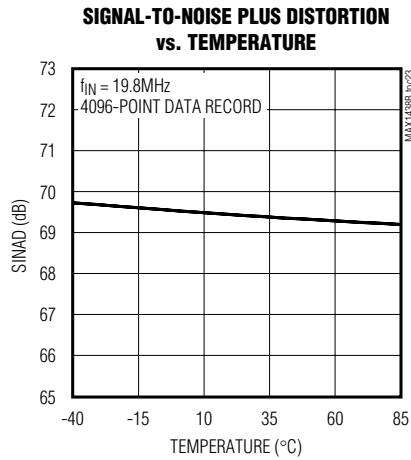
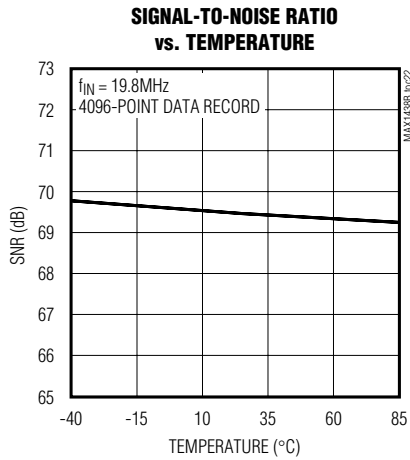
($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, internal reference, differential input at $-0.5dBFS$, $f_{IN} = 5.3MHz$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $C_{LOAD} = 10pF$, $T_A = +25^\circ C$, unless otherwise noted.)



Octal, 12-Bit, 64Mps, 1.8V ADC with Serial LVDS Outputs

Typical Operating Characteristics (continued)

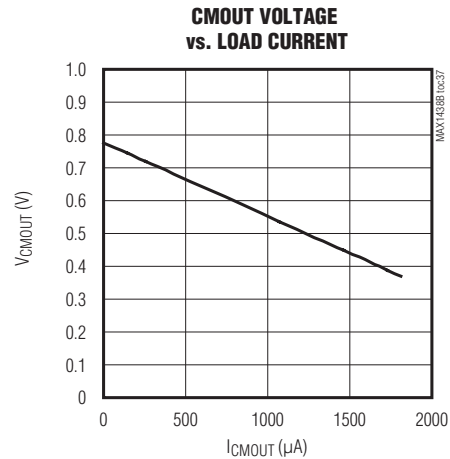
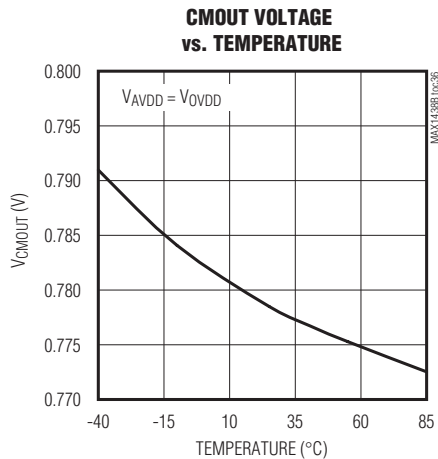
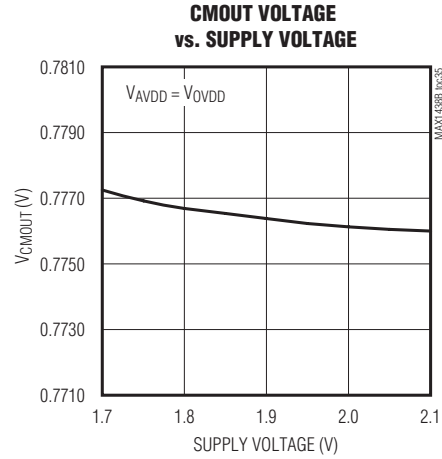
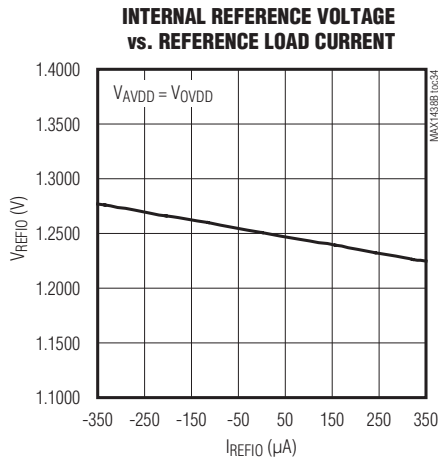
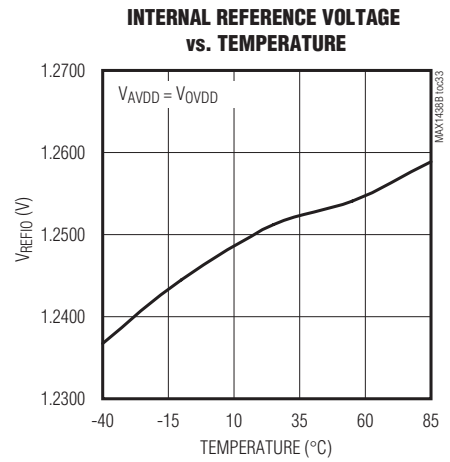
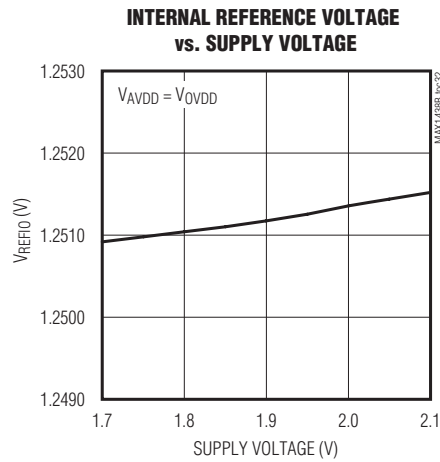
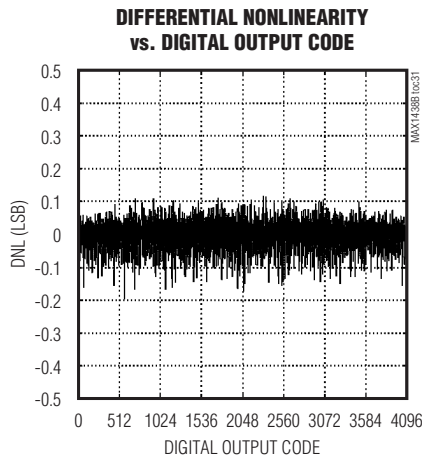
($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, internal reference, differential input at $-0.5dBFS$, $f_{IN} = 5.3MHz$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $C_{LOAD} = 10pF$, $T_A = +25^\circ C$, unless otherwise noted.)



Octal, 12-Bit, 64Mps, 1.8V ADC with Serial LVDS Outputs

Typical Operating Characteristics (continued)

($V_{AVDD} = 1.8V$, $V_{OVDD} = 1.8V$, $V_{CVDD} = 1.8V$, $V_{GND} = 0V$, internal reference, differential input at $-0.5dBFS$, $f_{IN} = 5.3MHz$, $f_{CLK} = 64MHz$ (50% duty cycle), $DT = 0$, $C_{LOAD} = 10pF$, $T_A = +25^\circ C$, unless otherwise noted.)



Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

Pin Description

| PIN | NAME | FUNCTION |
|---------------------------------|-----------|--|
| 1 | IN1P | Channel 1 Positive Input |
| 2 | IN1N | Channel 1 Negative Input |
| 3 | IN2P | Channel 2 Positive Input |
| 4 | IN2N | Channel 2 Negative Input |
| 5 | IN3P | Channel 3 Positive Input |
| 6 | IN3N | Channel 3 Negative Input |
| 7, 8, 10, 11, 25, 26, 27, 60 | AVDD | Analog Power Input. Connect AVDD to a 1.7V to 1.9V power supply. Bypass AVDD to GND with a 0.1µF capacitor as close as possible to the device. Bypass the AVDD power plane to the GND plane with a bulk capacitor of at least 2.2µF. Connect all AVDD pins to the same potential. |
| 9, 18, 68 | GND | Ground. Connect all GND pins to the same potential. |
| 12 | IN4P | Channel 4 Positive Input |
| 13 | IN4N | Channel 4 Negative Input |
| 14 | IN5P | Channel 5 Positive Input |
| 15 | IN5N | Channel 5 Negative Input |
| 16 | IN6P | Channel 6 Positive Input |
| 17 | IN6N | Channel 6 Negative Input |
| 19 | IN7P | Channel 7 Positive Input |
| 20 | IN7N | Channel 7 Negative Input |
| 21 | DT | Double Termination Select. Force DT high to select the internal 100Ω termination between the differential output pairs. Force DT low to select no internal output termination. |
| 22 | SLVS/LVDS | Differential Output Signal Format Select Input. Force SLVS/LVDS high to select SLVS outputs. Force SLVS/LVDS low to select LVDS outputs. |
| 23 | CVDD | Clock Power Input. Connect CVDD to a 1.7V to 3.5V supply. Bypass CVDD to GND with a 0.1µF capacitor in parallel with a capacitor of at least 2.2µF. Install the bypass capacitors as close as possible to the device. CVDD is used to bias ESD-protection diodes on CLK (see Figure 2). |
| 24 | CLK | Single-Ended CMOS Clock Input |
| 28, 31, 34, 39, 44, 49, 52 | OVDD | Output Driver Power Input. Connect OVDD to a 1.7V to 1.9V power supply. Bypass OVDD to GND with a 0.1µF capacitor as close as possible to the device. Bypass the OVDD power plane to the GND plane with a bulk capacitor of at least 2.2µF. Connect all OVDD pins to the same potential. |
| 29 | OUT7N | Channel 7 Negative LVDS/SLVS Output |
| 30 | OUT7P | Channel 7 Positive LVDS/SLVS Output |
| 32 | OUT6N | Channel 6 Negative LVDS/SLVS Output |
| 33 | OUT6P | Channel 6 Positive LVDS/SLVS Output |
| 35 | OUT5N | Channel 5 Negative LVDS/SLVS Output |
| 36 | OUT5P | Channel 5 Positive LVDS/SLVS Output |
| 37 | OUT4N | Channel 4 Negative LVDS/SLVS Output |
| 38 | OUT4P | Channel 4 Positive LVDS/SLVS Output |
| 40 | FRAMEN | Negative Frame-Alignment LVDS/SLVS Output. A rising edge on the differential FRAME output aligns to a valid D0 in the output data stream. |
| 41 | FRAMEP | Positive Frame-Alignment LVDS/SLVS Output. A rising edge on the differential FRAME output aligns to a valid D0 in the output data stream. |
| 42 | CLKOUTN | Negative LVDS/SLVS Serial Clock Output |

Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

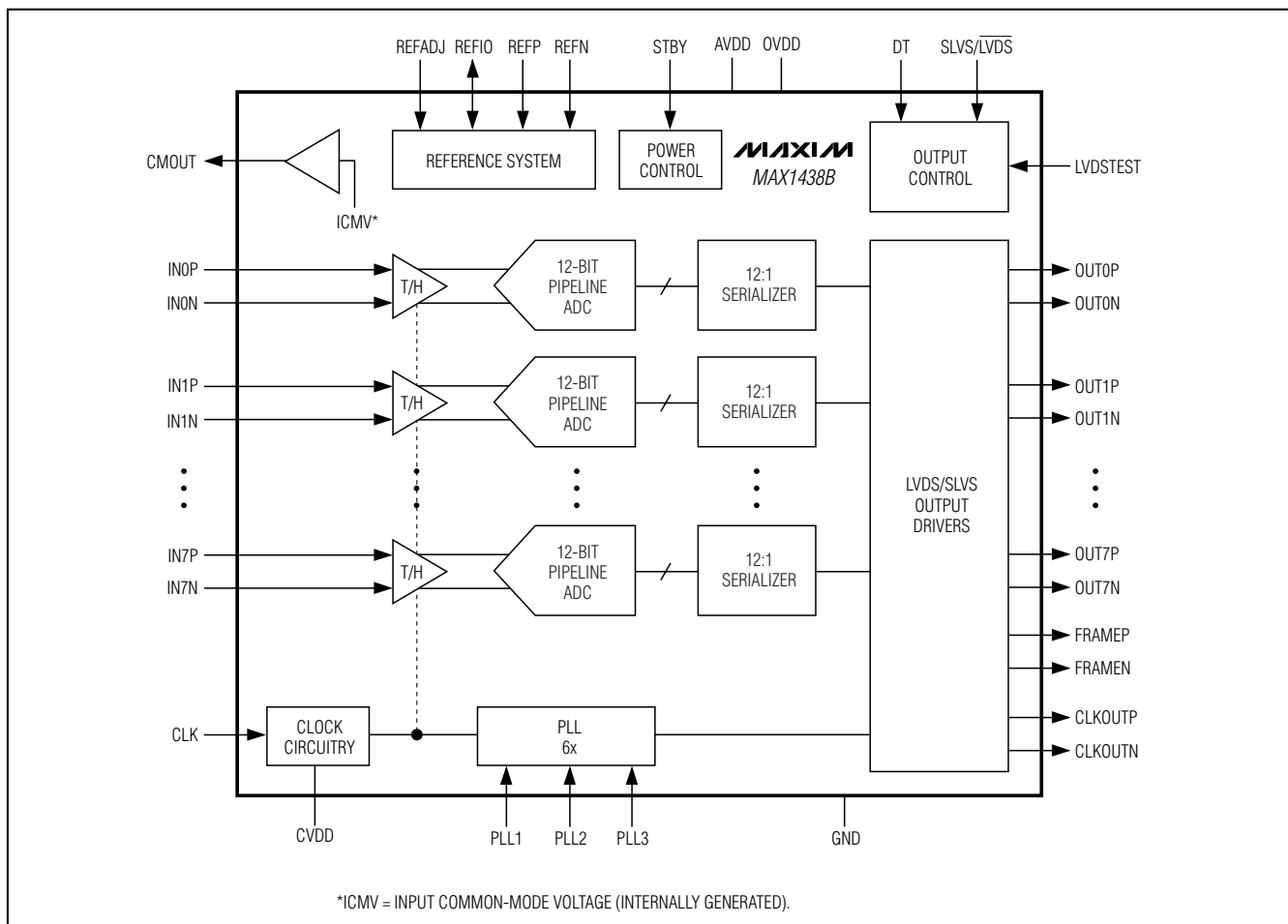
Pin Description (continued)

| PIN | NAME | FUNCTION |
|-----|----------|---|
| 43 | CLKOUTP | Positive LVDS/SLVS Serial-Clock Output |
| 45 | OUT3N | Channel 3 Negative LVDS/SLVS Output |
| 46 | OUT3P | Channel 3 Positive LVDS/SLVS Output |
| 47 | OUT2N | Channel 2 Negative LVDS/SLVS Output |
| 48 | OUT2P | Channel 2 Positive LVDS/SLVS Output |
| 50 | OUT1N | Channel 1 Negative LVDS/SLVS Output |
| 51 | OUT1P | Channel 1 Positive LVDS/SLVS Output |
| 53 | OUT0N | Channel 0 Negative LVDS/SLVS Output |
| 54 | OUT0P | Channel 0 Positive LVDS/SLVS Output |
| 55 | LVDSTEST | LVDS Test Pattern Enable. Force LVDSTEST high to enable the output test pattern, 0000 1011 1101. As with the analog conversion results, the test pattern data are output LSB first. Force LVDSTEST low for normal operation. |
| 56 | STBY | Standby Input. Force STBY high to put the MAX1438B into standby mode. In standby, the reference circuitry remains active. Force STBY low for normal operation. |
| 57 | PLL3 | PLL Control Input 3. See Table 1 for details. |
| 58 | PLL2 | PLL Control Input 2. See Table 1 for details. |
| 59 | PLL1 | PLL Control Input 1. See Table 1 for details. |
| 61 | REFN | Negative Reference Bypass Output. Connect a capacitor of at least 1 μ F (10 μ F typ) between REFP and REFN, and connect a capacitor of at least 1 μ F (10 μ F typ) between REFN and GND. Place the capacitors as close as possible to the device on the same side of the PCB as the MAX1438B. |
| 62 | REFP | Positive Reference Bypass Output. Connect a capacitor of at least 1 μ F (10 μ F typ) between REFP and REFN, and connect a capacitor of at least 1 μ F (10 μ F typical) between REFN and GND. Place the capacitors as close as possible to the device on the same side of the PCB as the MAX1438B. |
| 63 | REFIO | Reference Input/Output. For internal reference operation (REFADJ = GND), the reference output voltage is 1.24V. For external reference operation (REFADJ = AVDD), apply a stable reference voltage at REFIO. Bypass to GND with a capacitor of at least 0.1 μ F. |
| 64 | REFADJ | Internal/External Reference Mode Select and Reference Adjust Input. For internal reference, connect REFADJ to GND. For external reference, connect REFADJ to AVDD. For adjusting the reference, see the <i>Full-Scale Range Adjustments Using the Internal Reference</i> section. |
| 65 | CMOUT | Common-Mode Reference Voltage Output. CMOUT outputs the input common-mode voltage for DC-coupled applications. Bypass CMOUT to GND with a capacitor of at least 0.1 μ F. |
| 66 | IN0P | Channel 0 Positive Input |
| 67 | IN0N | Channel 0 Negative Input |
| — | EP | Exposed Pad. Internally connected to GND. Connect EP to a large ground plane for maximum thermal performance. Must be connected to GND. |

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Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

Functional Diagram



Detailed Description

The MAX1438B ADC features fully differential inputs, a pipelined architecture, and digital error correction for high-speed signal conversion. The ADC pipeline architecture moves the samples taken at the inputs through the pipeline stages every half clock cycle. The converted digital results are serialized and sent through the LVDS/SLVS output drivers. The total clock-cycle latency from input to output is 6.5 clock cycles.

The MAX1438B offers 8 separate fully differential channels with synchronized inputs and outputs. Global standby minimizes power consumption.

Input Circuit

Figure 1 displays a simplified diagram of the input T/H circuits. In track mode, switches S1, S2a, S2b, S4a, S4b, S5a, and S5b are closed. The fully differential circuits sample the input signals onto the two capacitors (C2a and C2b) through switches S4a and S4b. S2a and S2b set the common mode for the operational transconductance amplifier (OTA), and open simultaneously with S1, sampling the input waveform. Switches S4a, S4b, S5a, and S5b are then opened before switches S3a and S3b connect capacitors C1a and C1b to the output of the amplifier and switch S4c is closed. The resulting differential voltages are held on capacitors C2a and C2b. The amplifiers charge capacitors C1a and C1b to the same values originally held on C2a and C2b. These values are

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Reference Configurations (REFIO, REFADJ, REFP, and REFN)

$$FSR = \frac{(0.700 \times V_{REFIO})}{1.24V}$$

Internal Reference Mode

To compensate for gain errors or to decrease or increase the ADC's FSR, add an external resistor between REFADJ and GND or REFADJ and REFIO. This adjusts the internal reference value of the MAX1438B by up to $\pm 5\%$ of its nominal value. See the *Full-Scale Range Adjustments Using the Internal Reference* section.

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Connect $\geq 1\mu\text{F}$ ($10\mu\text{F}$ typ) capacitors to GND from REFP and REFN and a $\geq 1\mu\text{F}$ ($10\mu\text{F}$ typ) capacitor between REFP and REFN as close as possible to the device on the same side of the PCB.

External Reference Mode

The external reference mode allows for more control over the MAX1438B reference voltage and allows multiple converters to use a common reference. Connect REFADJ to AVDD to disable the internal reference. Apply a stable 1.18V to 1.30V source at REFIO. Bypass REFIO to GND with a $\geq 0.1\mu\text{F}$ capacitor. The REFIO input impedance is $> 1\text{M}\Omega$.

Clock Input (CLK)

The MAX1438B accepts a CMOS-compatible clock signal with a wide 20% to 80% input clock duty cycle. Drive CLK with an external single-ended clock signal. Figure 2 shows the simplified clock input diagram.

Low clock jitter is required for the specified SNR performance of the MAX1438B. Analog input sampling occurs on the rising edge of CLK, requiring this edge to provide the lowest possible jitter. Jitter limits the maximum SNR performance of any ADC according to the following relationship:

$$\text{SNR} = 20 \times \log \left(\frac{1}{2 \times \pi \times f_{\text{IN}} \times t_{\text{J}}} \right)$$

where f_{IN} represents the analog input frequency and t_{J} is the total system clock jitter.

PLL Inputs (PLL1, PLL2, PLL3)

The MAX1438B features a PLL that generates an output clock signal with six times the frequency of the input clock. The output clock signal is used to clock data out of the MAX1438B (see the *System Timing Requirements*

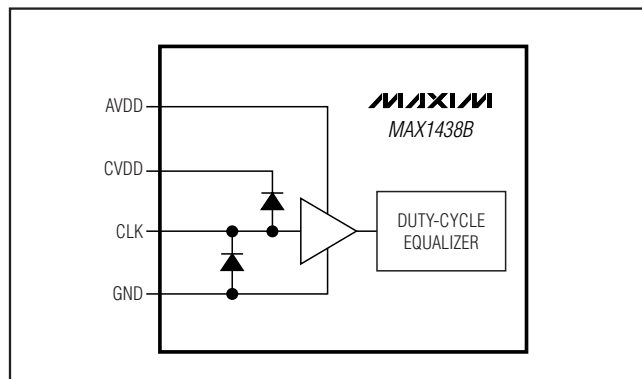


Figure 2. Clock Input Circuitry

Table 1. PLL1, PLL2, and PLL3 Configuration Table

| PLL1 | PLL2 | PLL3 | INPUT CLOCK RANGE (MHz) | |
|------|------|------|-------------------------|------|
| | | | MIN | MAX |
| 0 | 0 | 0 | 45.0 | 64.0 |
| 0 | 0 | 1 | 32.5 | 45.0 |
| 0 | 1 | 0 | 22.5 | 32.5 |
| 0 | 1 | 1 | 16.3 | 22.5 |
| 1 | 0 | 0 | 11.3 | 16.3 |
| 1 | 0 | 1 | 8.1 | 11.3 |
| 1 | 1 | 0 | 5.6 | 8.1 |
| 1 | 1 | 1 | 4.0 | 5.6 |

section). Set the PLL1, PLL2, and PLL3 pins according to the input clock range provided in Table 1.

System Timing Requirements

Figure 3 shows the relationship between the analog inputs, input clock, frame-alignment output, serial-clock output, and serial-data output. The differential analog input (IN_P and IN_N) is sampled on the rising edge of the CLK signal and the resulting data appears at the digital outputs 6.5 clock cycles later. Figure 4 provides a detailed, two-conversion timing diagram of the relationship between the inputs and the outputs.

Clock Output (CLKOUTP, CLKOUTN)

The MAX1438B provides a differential clock output that consists of CLKOUTP and CLKOUTN. As shown in Figure 4, the serial output data is clocked out of the MAX1438B on both edges of the clock output. The frequency of the output clock is six times the frequency of CLK.

Frame-Alignment Output (FRAMEP, FRAMEN)

The MAX1438B provides a differential frame-alignment signal that consists of FRAMEP and FRAMEN. As shown in Figure 4, the rising edge of the frame-alignment signal corresponds to the first bit (D0) of the 12-bit serial data stream. The frequency of the frame-alignment signal is identical to the frequency of the input clock.

Serial Output Data (OUT_P, OUT_N)

The MAX1438B provides its conversion results through individual differential outputs consisting of OUT_P and OUT_N. The results are valid 6.5 input clock cycles after the sample is taken. As shown in Figure 3, the output data is clocked out on both edges of the output clock, LSB (D0) first. Figure 5 provides the detailed serial-output timing diagram.

Octal, 12-Bit, 64MSPS, 1.8V ADC with Serial LVDS Outputs

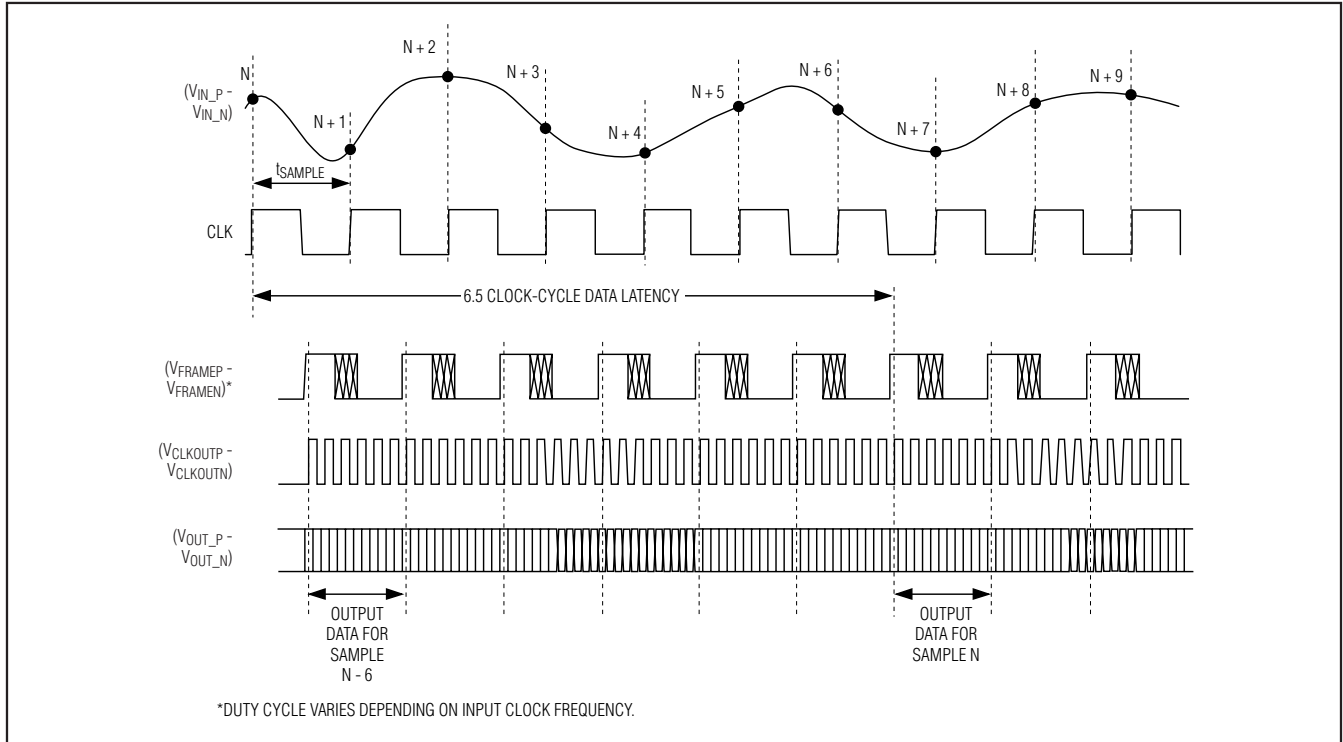


Figure 3. Global Timing Diagram

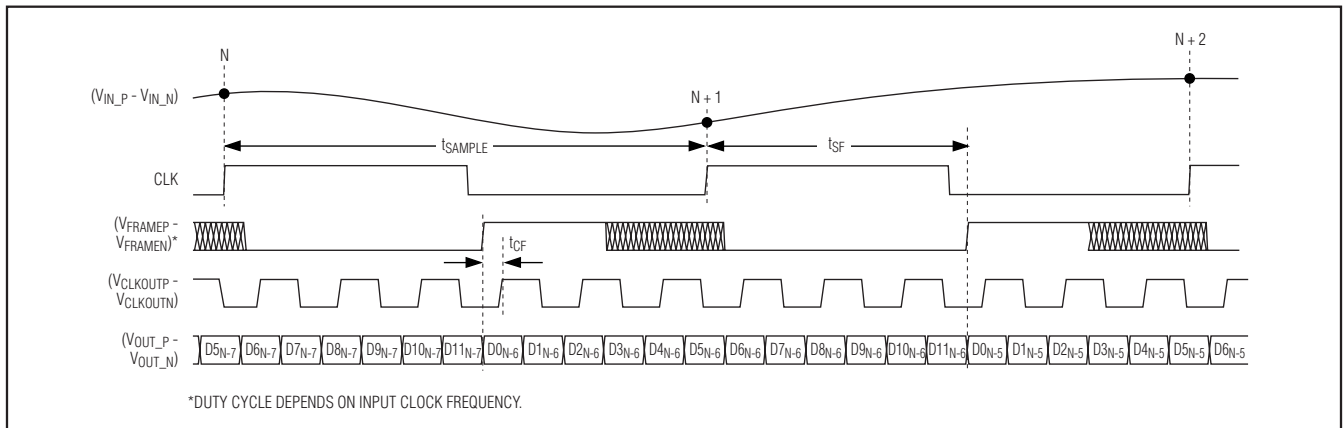


Figure 4. Detailed Two-Conversion Timing Diagram

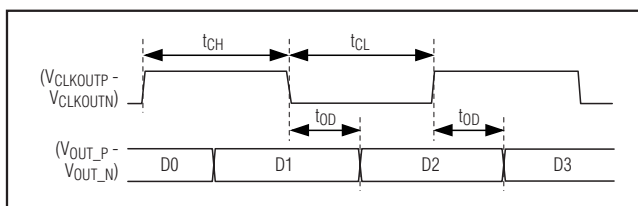


Figure 5. Serialized-Output Detailed Timing Diagram

Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

Table 2. Output Code Table (VREFIO = 1.24V)

| TWO'S-COMPLEMENT DIGITAL OUTPUT CODE | | | VIN_P - VIN_N (mV) (VREFIO = 1.24V) |
|--------------------------------------|---------------------------------------|-----------------------------------|--|
| BINARY D11 → D0 | HEXADECIMAL EQUIVALENT OF D11 → D0 | DECIMAL EQUIVALENT OF D11 → D0 | |
| 0111 1111 1111 | 0x7FF | +2047 | +699.66 |
| 0111 1111 1110 | 0x7FE | +2046 | +699.32 |
| 0000 0000 0001 | 0x001 | +1 | +0.34 |
| 0000 0000 0000 | 0x000 | 0 | 0 |
| 1111 1111 1111 | 0xFFF | -1 | -0.34 |
| 1000 0000 0001 | 0x801 | -2047 | -699.66 |
| 1000 0000 0000 | 0x800 | -2048 | -700.00 |

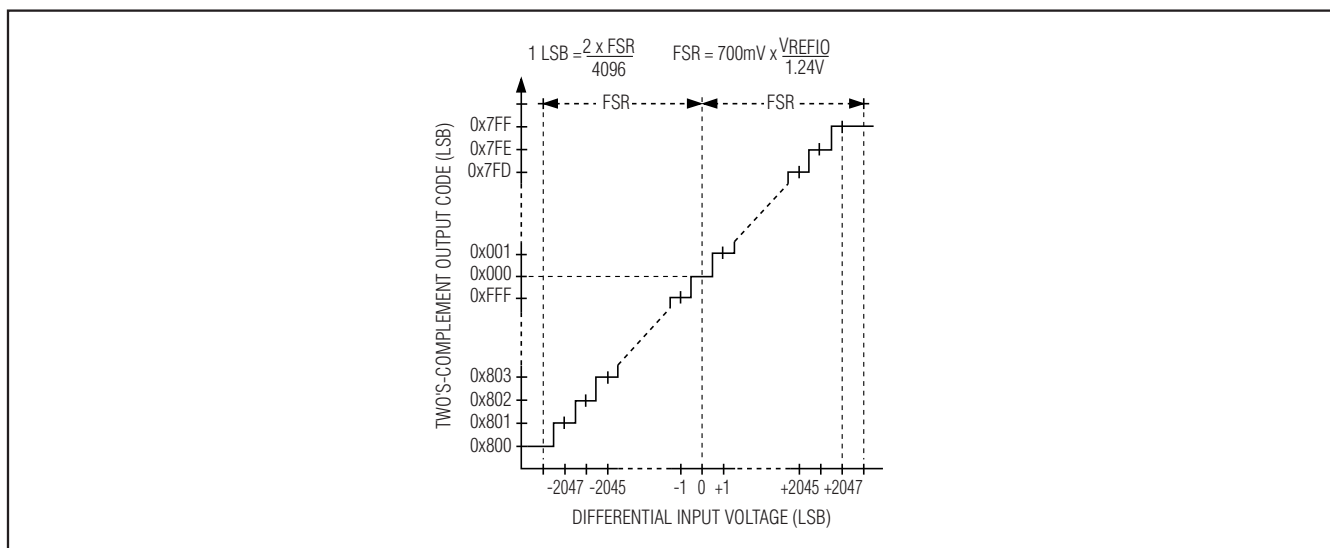


Figure 6. Two's-Complement Transfer Function

Output Data Transfer Function

The MAX1438B output data format is two's complement. The following equation, Table 2, and Figure 6 define the relationship between the digital output and the analog input:

$$V_{IN_P} - V_{IN_N} = FSR \times 2 \times \frac{CODE_{10}}{4096}$$

where CODE₁₀ is the decimal equivalent of the digital output code as shown in Table 2.

Keep the capacitive load on the MAX1438B digital outputs as low as possible.

LVDS and SLVS Selection (SLVS/LVDS)

Drive SLVS/LVDS low for LVDS or drive SLVS/LVDS high for SLVS levels at the MAX1438B outputs (OUT_P, OUT_N, CLKOUTP, CLKOUTN, FRAMEP, and FRAME_N). For SLVS levels, enable double-termination by driving DT high. See the *Electrical Characteristics* table for LVDS and SLVS output voltage levels.

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LVDS Test Pattern (LVDSTEST)

Drive LVDSTEST high to enable the output test pattern on all LVDS or SLVS output channels. The output test pattern is 0000 1011 1101. Drive LVDSTEST low for normal operation (test pattern disabled).

Common-Mode Output (CMOUT)

CMOUT provides a common-mode reference for DC-coupled analog inputs. If the input is DC-coupled, match the output common-mode voltage of the circuit driving the MAX1438B to the output voltage at VCMOUT to within $\pm 50\text{mV}$. It is recommended that the output common-mode voltage of the driving circuit be derived from CMOUT.

Double Termination (DT)

The MAX1438B offers an optional, internal 100Ω termination between the differential output pairs (OUT_P and OUT_N, CLKOUTP and CLKOUTN, FRAMEP and FRAMEN). In addition to the termination at the end of the line, a second termination directly at the outputs helps eliminate unwanted reflections down the line. This feature is useful in applications where trace lengths are long ($> 5\text{in}$) or with mismatched impedance. Drive DT high to select double-termination, or drive DT low to disconnect the internal termination resistor (single-termination). Selecting double-termination increases the OVDD supply current (see Figure 7).

Standby Mode

The MAX1438B offers a standby mode to efficiently use power by transitioning to a low-power state when conversions are not required. STBY controls the standby mode of all channels and the internal reference circuitry. The reference does not power down in standby mode. Drive STBY high to enable standby. In standby mode, the output impedance of all of the LVDS/SLVS outputs is approximately 342Ω , if DT is low. The output impedance of the differential LVDS/SLVS outputs is 100Ω when DT is high. See the *Electrical Characteristics* table for typical supply currents during standby. The following list shows the state of the analog inputs and digital outputs in standby mode:

- IN_P, IN_N analog inputs are disconnected from the internal input amplifier.
- Reference circuit remains active.
- OUT_P, OUT_N, CLKOUTP, CLKOUTN, FRAMEP, and FRAMEN have approximately 342Ω between the output pairs when DT is low. When DT is high, the differential output pairs have 100Ω between each pair.

When operating in internal reference mode, the MAX1438B requires $200\mu\text{s}$ to power up and settle when

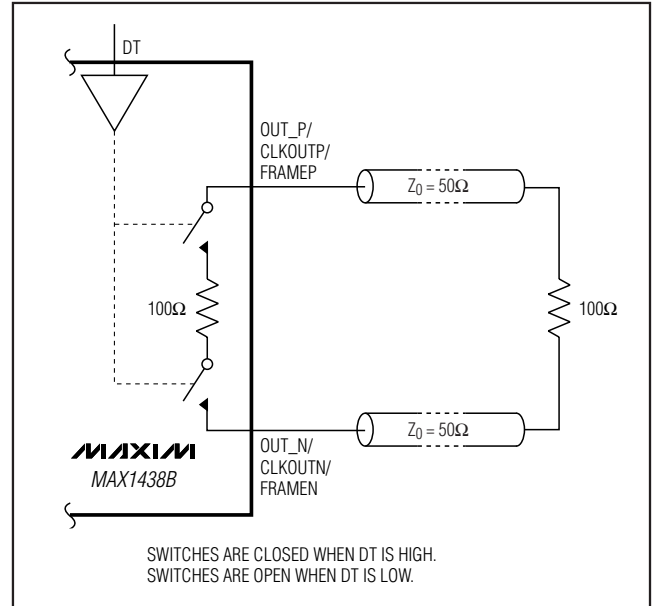


Figure 7. Double Termination

the converter exits standby mode. To exit standby mode, STBY, the applied control signal must transition from high to low. When using an external reference, the wake-up time is dependent on the external reference drivers.

Applications Information

Full-Scale Range Adjustments Using the Internal Reference

The MAX1438B supports a full-scale adjustment range of 10% ($\pm 5\%$). To decrease the full-scale range, add a $25\text{k}\Omega$ to $250\text{k}\Omega$ external resistor or potentiometer (R_{ADJ}) between REFADJ and GND. To increase the full-scale range, add a $25\text{k}\Omega$ to $250\text{k}\Omega$ resistor between REFADJ and REFIO. Figure 8 shows the two possible configurations.

The following equations provide the relationship between R_{ADJ} and the change in the analog full-scale range:

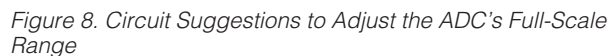
$$\text{FSR} = 0.7V \left(1 + \frac{1.25\text{k}\Omega}{R_{\text{ADJ}}} \right)$$

for R_{ADJ} connected between REFADJ and REFIO, and:

$$\text{FSR} = 0.7V \left(1 - \frac{1.25\text{k}\Omega}{R_{\text{ADJ}}} \right)$$

for R_{ADJ} connected between REFADJ and GND.

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An RF transformer (Figure 9) provides an excellent solution to convert a single-ended input source signal to a fully differential signal. The MAX1438B input common-mode voltage is internally biased to 0.76V (typ) with $f_{CLK} = 64\text{MHz}$. Although a 1:1 transformer is shown, a step-up transformer can be selected to reduce the drive requirements. A reduced signal swing from the input driver, such as an op amp, can also improve the overall distortion.

Multilayer boards with ample ground and power planes produce the highest level of signal integrity. Connect



Ensure that the differential analog input network layout is symmetric and that all parasitics are balanced equally. Refer to the MAX1438B EV kit data sheet for an example of symmetric input layout.

DNL is the difference between an actual step width and the ideal value of 1 LSB. A DNL error specification of less than 1 LSB guarantees no missing codes and a monotonic transfer function. For the MAX1438B, DNL deviations are measured at every step and the worst-case deviation is reported in the *Electrical Characteristics* table.

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Offset Error

Offset error is a figure of merit that indicates how well the actual transfer function matches the ideal transfer function at a single point. For the MAX1438B, the ideal midscale digital output transition occurs when there is $-1/2$ LSBs across the analog inputs (Figure 6). Bipolar offset error is the amount of deviation between the measured midscale transition point and the ideal midscale transition point.

Gain Error

Gain error is a figure of merit that indicates how well the slope of the actual transfer function matches the slope of the ideal transfer function. For the MAX1438B, the gain error is the difference of the measured full-scale and zero-scale transition points minus the difference of the ideal full-scale and zero-scale transition points.

For the bipolar device (MAX1438B), the full-scale transition point is from 0x7FE to 0x7FF and the zero-scale transition point is from 0x800 to 0x801.

Crosstalk

Crosstalk indicates how well each analog input is isolated from the others. For the MAX1438B, a 5.3MHz, -0.5dBFS analog signal is applied to 1 channel while a 30.3MHz, -0.5dBFS analog signal is applied to another channel. An FFT is taken on the channel with the 5.3MHz analog signal. From this FFT, the crosstalk is measured as the difference in the 5.3MHz and 30.3MHz amplitudes.

Aperture Delay

Aperture delay (t_{AD}) is the time defined between the rising edge of the sampling clock and the instant when an actual sample is taken. See Figure 10.

Aperture Jitter

Aperture jitter (t_{AJ}) is the sample-to-sample variation in the aperture delay. See Figure 10.

Signal-to-Noise Ratio (SNR)

For a waveform perfectly reconstructed from digital samples, the theoretical maximum SNR is the ratio of the full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical minimum analog-to-digital noise is caused by quantization error only and results directly from the ADC's resolution (N bits):

$$\text{SNR}_{\text{dB}[\text{max}]} = 6.02\text{dB} \times N + 1.76\text{dB}$$

In reality, there are other noise sources besides quantization noise: thermal noise, reference noise, clock jitter, etc.

For the MAX1438B, SNR is computed by taking the ratio of the RMS signal to the RMS noise. RMS noise

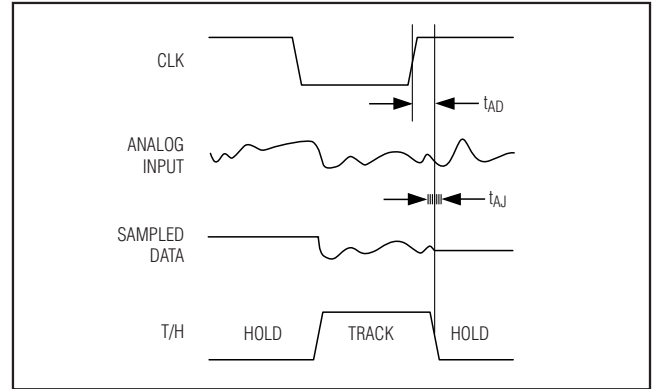


Figure 10. Aperture Jitter/Delay Specifications

includes all spectral components to the Nyquist frequency excluding the fundamental, the first six harmonics (HD2–HD7), and the DC offset.

Signal-to-Noise Plus Distortion (SINAD)

SINAD is computed by taking the ratio of the RMS signal to the RMS noise plus distortion. RMS noise plus distortion includes all spectral components to the Nyquist frequency, excluding the fundamental and the DC offset.

Effective Number of Bits (ENOB)

ENOB specifies the dynamic performance of an ADC at a specific input frequency and sampling rate. An ideal ADC's error consists of quantization noise only. ENOB for a full-scale sinusoidal input waveform is computed from:

$$\text{ENOB} = \left(\frac{\text{SINAD} - 1.76}{6.02} \right)$$

Total Harmonic Distortion (THD)

THD is the ratio of the RMS sum of the first six harmonics of the input signal to the fundamental itself. This is expressed as:

$$\text{THD} = 20 \times \log \left(\frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2 + V_7^2}}{V_1} \right)$$

Spurious-Free Dynamic Range (SFDR)

SFDR is the ratio expressed in decibels of the RMS amplitude of the fundamental (maximum signal component) to the RMS value of the next-largest spurious component, excluding DC offset. SFDR is specified in decibels relative to the carrier (dBc).

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Intermodulation Distortion (IMD)

IMD is the total power of the IM2 to IM5 intermodulation products to the Nyquist frequency relative to the total input power of the two input tones, f_1 and f_2 . The individual input tone levels are at -6.5dBFS. The intermodulation products are as follows:

- 2nd-order intermodulation products (IM2): $f_1 + f_2$, $f_2 - f_1$
- 3rd-order intermodulation products (IM3): $2 \times f_1 - f_2$, $2 \times f_2 - f_1$, $2 \times f_1 + f_2$, $2 \times f_2 + f_1$
- 4th-order intermodulation products (IM4): $3 \times f_1 - f_2$, $3 \times f_2 - f_1$, $3 \times f_1 + f_2$, $3 \times f_2 + f_1$
- 5th-order intermodulation products (IM5): $3 \times f_1 - 2 \times f_2$, $3 \times f_2 - 2 \times f_1$, $3 \times f_1 + 2 \times f_2$, $3 \times f_2 + 2 \times f_1$

Third-Order Intermodulation (IM3)

IM3 is the total power of the 3rd-order intermodulation product to the Nyquist frequency relative to the total input power of the two input tones, f_1 and f_2 . The individual input tone levels are at -6.5dBFS. The 3rd-order intermodulation products are $2 \times f_1 - f_2$, $2 \times f_2 - f_1$, $2 \times f_1 + f_2$, $2 \times f_2 + f_1$.

Small-Signal Bandwidth

A small -20.5dBFS analog input signal is applied to an ADC so that the signal's slew rate does not limit the ADC's performance. The input frequency is then swept up to the point where the amplitude of the digitized conversion result has decreased by -3dB.

Full-Power Bandwidth

A large -0.5dBFS analog input signal is applied to an ADC, and the input frequency is swept up to the point where the amplitude of the digitized conversion result has decreased by -3dB. This point is defined as full-power input bandwidth frequency.

Gain Matching

Gain matching is a figure of merit that indicates how well the gain of all 8 ADC channels is matched to each other. For the MAX1438B, gain matching is measured by applying the same 5.3MHz, -0.5dBFS analog signal to all analog input channels. These analog inputs are sampled at 64Msps and the maximum deviation in amplitude is reported in dB as gain matching in the *Electrical Characteristics* table.

Phase Matching

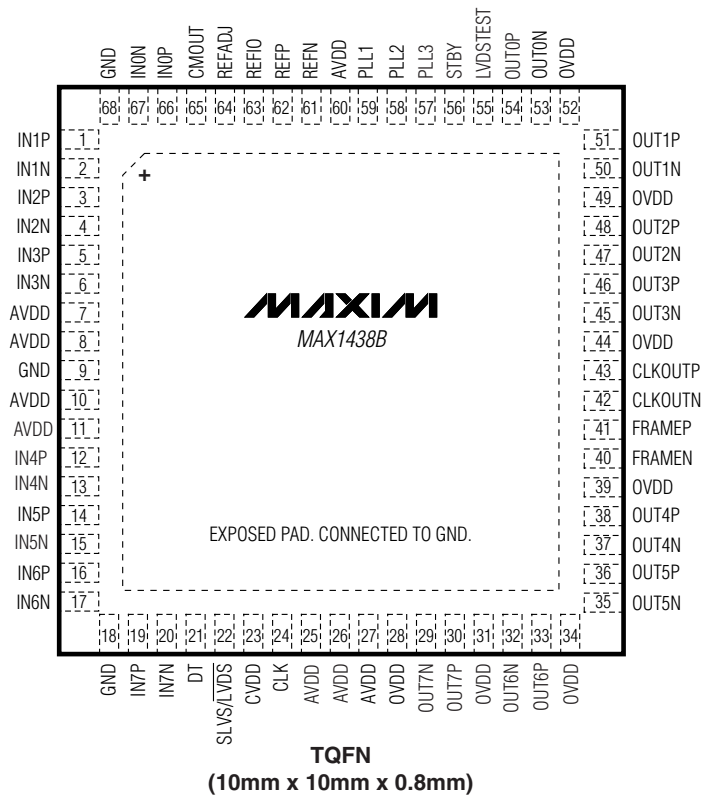
Phase matching is a figure of merit that indicates how well the phases of all 8 ADC channels are matched to each other. For the MAX1438B, phase matching is measured by applying the same 5.3MHz, -0.5dBFS analog signal to all analog input channels. These analog inputs are sampled at 64Msps and the maximum deviation in phase is reported in degrees as phase matching in the *Electrical Characteristics* table.

Octal, 12-Bit, 64Msps, 1.8V ADC with Serial LVDS Outputs

Pin Configuration

MAX1438B

TOP VIEW



Package Information

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| PACKAGE TYPE | PACKAGE CODE | DOCUMENT NO. |
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| 68 TQFN-EP | T6800-4 | 21-0142 |

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